

## 60V N-Channel Enhancement Mode MOSFET

### Description

The NP6003VR uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### General Features

- ◆  $V_{DS} = 60V \quad I_D = 3A$   
 $R_{DS(ON)} = 78m\Omega \quad @ V_{GS} = 10V \quad (\text{Typ: } 76m\Omega)$   
 $R_{DS(ON)} = 88m\Omega \quad @ V_{GS} = 4.5V \quad (\text{Typ: } 88m\Omega)$
- ◆ High density cell design for ultra low  $R_{DS(on)}$ .
- ◆ Fully characterized avalanche voltage and current.
- ◆ Low gate to drain charge to reduce switching losses.

### Application

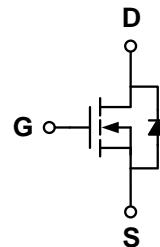
- ◆ Power switching application.
- ◆ Hard switched and high frequency circuits.
- ◆ Uninterruptible power supply.

### Package

- ◆ SOT-23

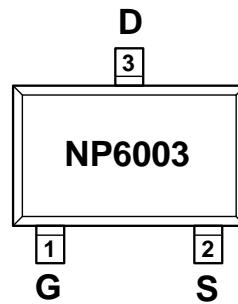


### Schematic diagram



### Marking and pin assignment

SOT-23  
(TOP VIEW)



### Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
NP6003VR-G	-55°C to +150°C	SOT-23	3000

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	$V_{DS}$	60	V
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current (TJ = 150 °C)	$T_C = 25^\circ C$	3	A
	$T_C = 70^\circ C$	2	
	$T_A = 25^\circ C$	1.6 <sup>b,c</sup>	
	$T_A = 70^\circ C$	1.3 <sup>b,c</sup>	
Continuous Source-Drain Diode Current	$T_C = 25^\circ C$	2.1	A
	$T_A = 25^\circ C$	1 <sup>b,c</sup>	
Pulsed Drain Current ( $t = 300 \mu s$ )	$I_{DM}$	12	
Maximum power dissipation	$P_D$	2.5	W

	T <sub>C</sub> =70°C		1.6	
	T <sub>A</sub> =25°C		1.25 <sup>b,c</sup>	
	T <sub>A</sub> =70°C		0.8 <sup>b,c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55—150	°C

## Thermal Characteristics

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, d</sup>	R <sub>θJA</sub>	100	130	°C/W
Maximum Junction-to-Foot (Drain)	R <sub>θJF</sub>	60	75	

Notes:

a:T<sub>C</sub> = 25 °C. b:Surface mounted on 1" x 1" FR4 board.

c:t = 5 s. d: Maximum under steady state conditions is 175 °C/W.

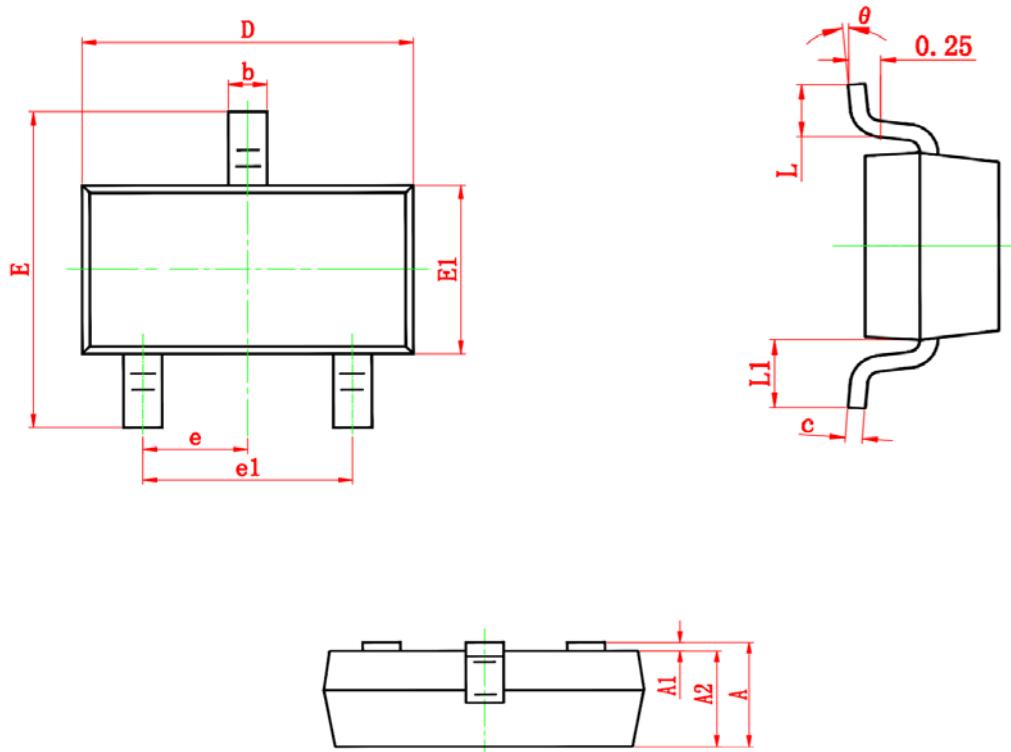
## Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	-	-	V
BVDSS Temperature Coefficient	△BV <sub>DSS</sub> /△T <sub>J</sub>	Reference to 25°C, ID=1mA		33		mV/°C
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	-	-	1	μA
		T <sub>J</sub> =85°C	-	-	30	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.2	1.9	2.5	V
Drain-source on-state resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3A	-	78	90	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A		88	100	
On Status Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V	3	-	-	A
<b>Diode Characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	I <sub>SD</sub> =1A, V <sub>GS</sub> =0V	-	0.75	1.1	V
Diode Continuous Forward Current	I <sub>S</sub>		-	-	3	A
Reverse Recovery Time	t <sub>rr</sub>	I <sub>f</sub> =1.5A, dI/dt=100A/us	-	15	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		-	12	-	nC
<b>Dynamic Characteristics<sup>2</sup></b>						
Gate Resistance	R <sub>G</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	-	2.0	-	Ω
Input capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V f=1.0MHz	-	175	-	pF
Output capacitance	C <sub>OSS</sub>		-	21	-	
Reverse transfer capacitance	C <sub>RSS</sub>		-	13	-	
Turn-on delay time	t <sub>D(ON)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =30V, R <sub>L</sub> =4.7Ω, I <sub>D</sub> =1.5A, R <sub>G</sub> =3.3Ω	-	15	-	ns
Turn-on Rise time	t <sub>r</sub>		-	16	-	
Turn-off delay time	t <sub>D(OFF)</sub>		-	10	-	
Turn-off Fall time	t <sub>f</sub>		-	10	-	

Total gate charge	$Q_g$	$V_{GS}=10V, I_D=2A$ $V_{DS}=30V$	-	4.1		nC
Gate-source charge	$Q_{gs}$			0.8		
Gate-drain charge	$Q_{gd}$		-	1	-	

## Package Information

- SOT-23



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	2.250	2.550	0.089	0.100
E1	1.200	1.400	0.047	0.055
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.300	0.500	0.012	0.020
L1	0.550 REF.		0.022 REF.	
θ	0°	8°	0°	8°

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